

NTR1P02T1

Power MOSFET

-20 V, -1 A, P-Channel SOT-23 Package

Features

- Ultra Low On-Resistance Provides Higher Efficiency and Extends Battery Life
 $R_{DS(on)} = 0.180 \Omega$, $V_{GS} = -10 \text{ V}$
 $R_{DS(on)} = 0.280 \Omega$, $V_{GS} = -4.5 \text{ V}$
- Power Management in Portable and Battery-Powered Products
- Miniature SOT-23 Surface Mount Package Saves Board Space
- Mounting Information for SOT-23 Package Provided

Applications

- DC-DC Converters
- Computers
- Printers
- PCMCIA Cards
- Cellular and Cordless Telephones

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DS}	-20	V
Gate-to-Source Voltage - Continuous	V_{GS}	± 20	V
Drain Current	I_D	-1.0	A
- Continuous @ $T_A = 25^\circ\text{C}$	I_{DM}	-2.67	
- Pulsed Drain Current ($t_p \leq 1 \mu\text{s}$)			
Total Power Dissipation @ $T_A = 25^\circ\text{C}$	P_D	400	mW
Operating and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$
Thermal Resistance - Junction-to-Ambient	$R_{\theta JA}$	300	$^\circ\text{C/W}$
Maximum Lead Temperature for Soldering Purposes, (1/8" from case for 10 s)	T_L	260	$^\circ\text{C}$

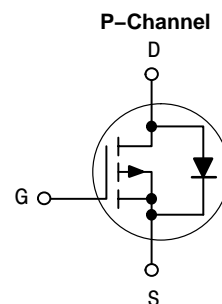
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



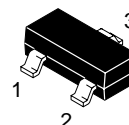
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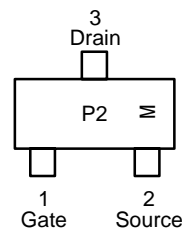
$V_{(BR)DSS}$	$R_{DS(on)}$ TYP	I_D MAX
-20 V	148 m Ω @ -10 V	-1.0 A



MARKING DIAGRAM/ PIN ASSIGNMENT



SOT-23
CASE 318
STYLE 21



P2 = Specific Device Code
M = Date Code

ORDERING INFORMATION

Device	Package	Shipping†
NTR1P02T1	SOT-23	3000/Tape & Reel
NTR1P02T3	SOT-23	10,000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Drain-to-Source Breakdown Voltage (V _{GS} = 0 V, I _D = -10 μA) (Positive Temperature Coefficient)	V _{(BR)DSS}	-20	32		V mV/°C
Zero Gate Voltage Drain Current (V _{DS} = -20 V, V _{GS} = 0 V, T _J = 25°C) (V _{DS} = -20 V, V _{GS} = 0 V, T _J = 150°C)	I _{DSS}			-1.0 -10	μA
Gate-Body Leakage Current (V _{GS} = ±20 V, V _{DS} = 0 V)	I _{GSS}			±100	nA

ON CHARACTERISTICS (Note 1)

Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = -250 μA) (Negative Temperature Coefficient)	V _{GS(th)}	-1.1	-1.9 -4.0	-2.3	V mV/°C
Static Drain-to-Source On-State Resistance (V _{GS} = -10 V, I _D = -1.5 A) (V _{GS} = -4.5 V, I _D = -0.75 A)	R _{DS(on)}		0.148 0.235	0.180 0.280	Ω

DYNAMIC CHARACTERISTICS

Input Capacitance (V _{DS} = -5 V, V _{GS} = 0 V, f = 1.0 MHz)	C _{iss}		165		pF
Output Capacitance (V _{DS} = -5 V, V _{GS} = 0 V, f = 1.0 MHz)	C _{oss}		110		
Reverse Transfer Capacitance (V _{DS} = -5 V, V _{GS} = 0 V, f = 1.0 MHz)	C _{rss}		35		

SWITCHING CHARACTERISTICS (Note 2)

Turn-On Delay Time (V _{DD} = -15 V, I _D = -1 A, V _{GS} = -5 V, R _G = 2.5 Ω)	t _{d(on)}		7.0		ns
Rise Time (V _{DD} = -15 V, I _D = -1 A, V _{GS} = -5 V, R _G = 2.5 Ω)	t _r		9.0		
Turn-Off Delay Time (V _{DD} = -15 V, I _D = -1 A, V _{GS} = -5 V, R _G = 2.5 Ω)	t _{d(off)}		9.0		
Fall Time (V _{DD} = -15 V, I _D = -1 A, V _{GS} = -5 V, R _G = 2.5 Ω)	t _f		3.0		
Total Gate Charge (V _{DS} = -15 V, V _{GS} = -5 V, I _D = -0.8 A)	Q _{tot}		2.5		nC
Gate-Source Charge (V _{DS} = -15 V, V _{GS} = -5 V, I _D = -0.8 A)	Q _{gs}		0.75		
Gate-Drain Charge (V _{DS} = -15 V, V _{GS} = -5 V, I _D = -0.8 A)	Q _{gd}		1.0		

BODY-DRAIN DIODE RATINGS (Note 1)

Diode Forward On-Voltage (Note 2) (I _S = -0.6 A, V _{GS} = 0 V) (I _S = -0.6 A, V _{GS} = 0 V, T _J = 150°C)	V _{SD}		-0.8 -0.6	-1.0	V
Reverse Recovery Time (I _S = -1 A, dI _S /dt = 100 A/μs, V _{GS} = 0 V)	t _{rr}		13.5		ns
	t _a		10.5		
	t _b		3.0		
Reverse Recovery Stored Charge (I _S = -1 A, dI _S /dt = 100 A/μs, V _{GS} = 0 V)	Q _{RR}		0.008		μC

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
2. Switching characteristics are independent of operating junction temperature.

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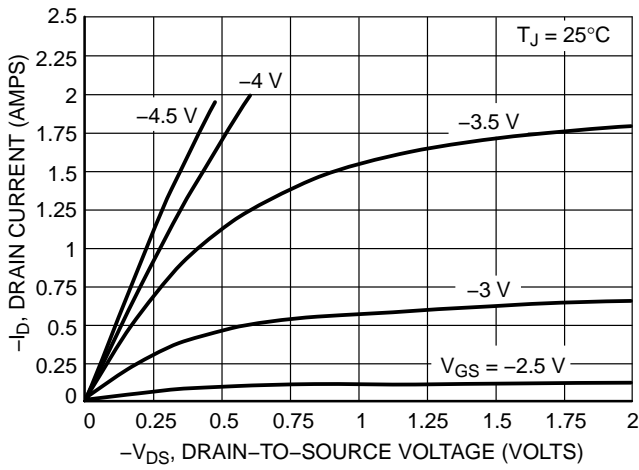


Figure 1. On-Region Characteristics

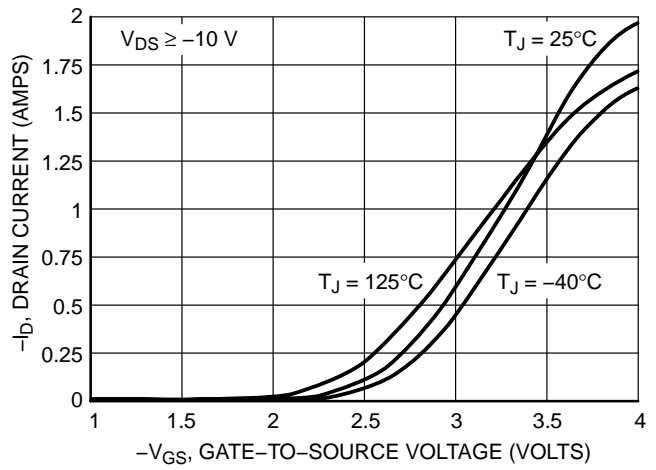


Figure 2. Transfer Characteristics

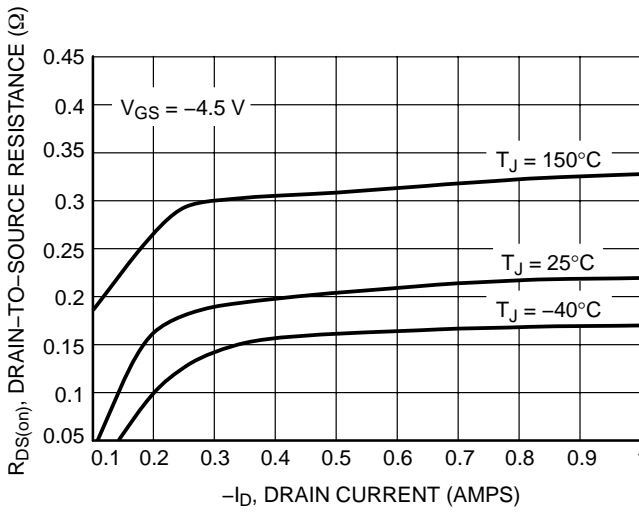


Figure 3. On-Resistance versus Drain Current and Temperature

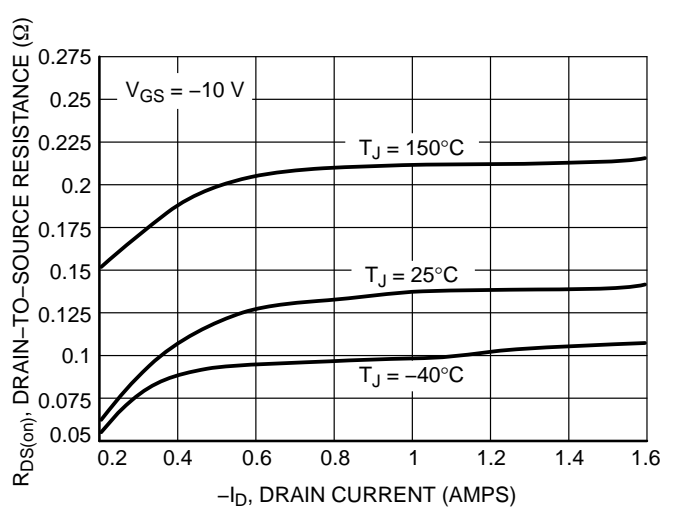


Figure 4. On-Resistance versus Drain Current and Temperature

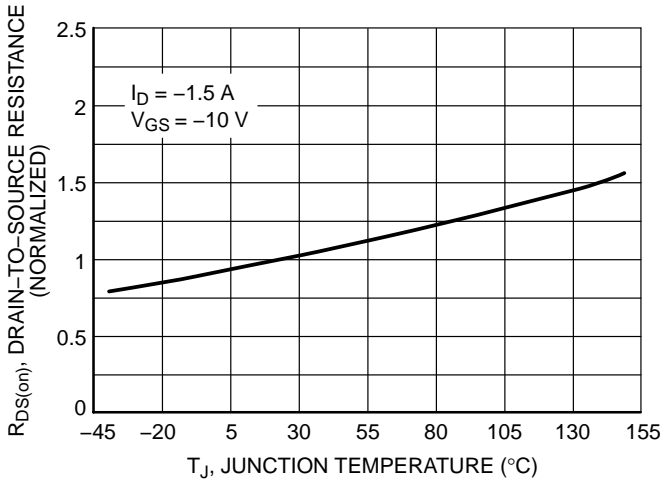


Figure 5. On-Resistance Variation with Temperature

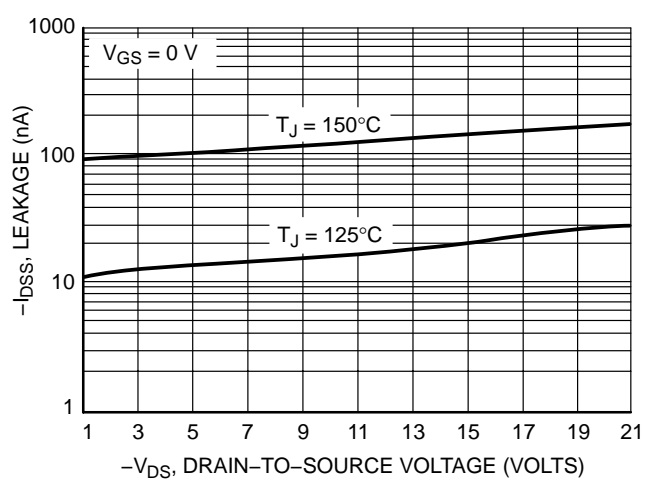
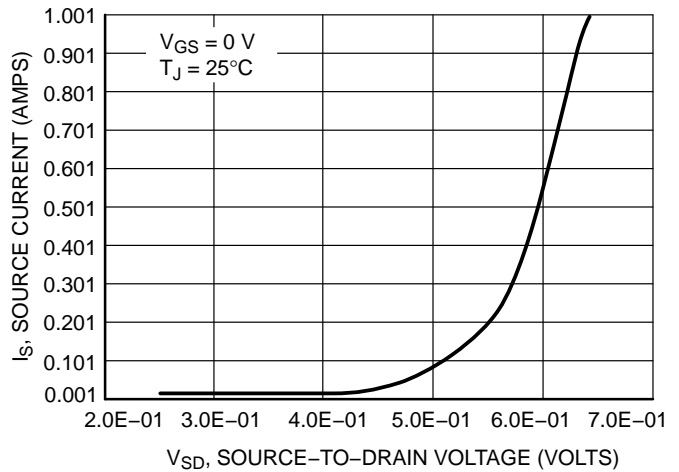
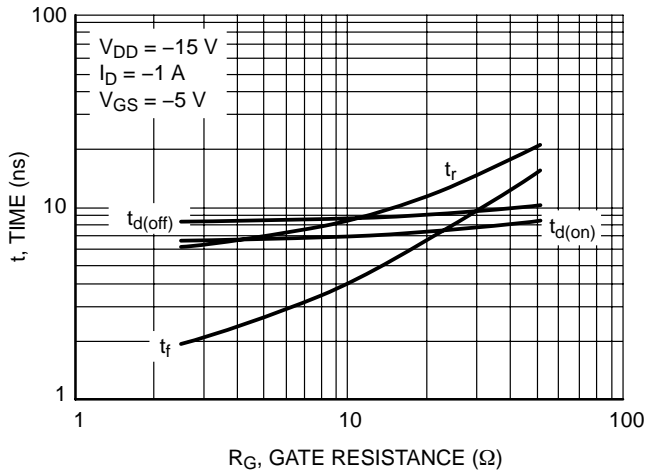
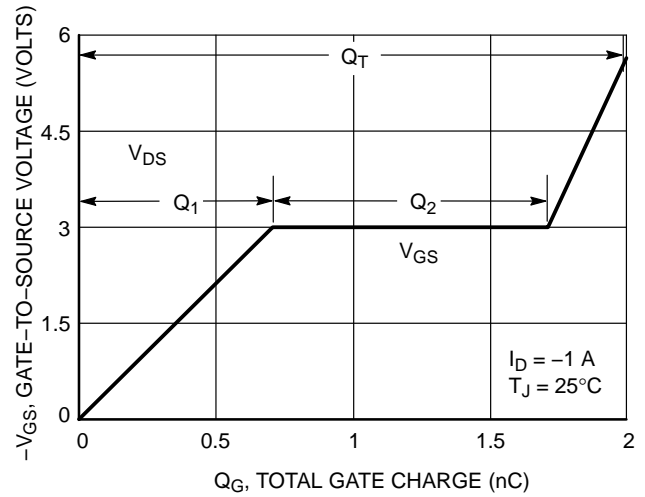
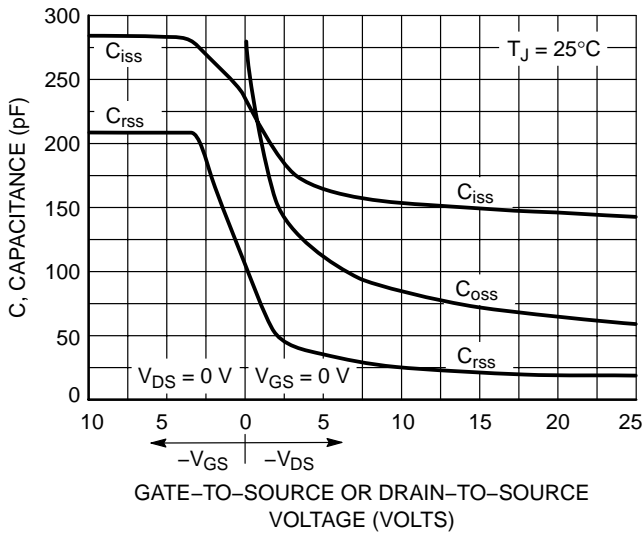


Figure 6. Drain-to-Source Leakage Current versus Voltage

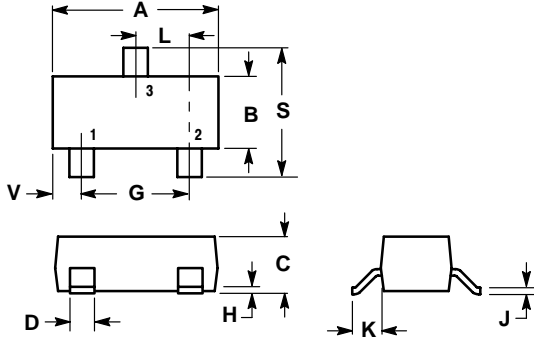
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PACKAGE DIMENSIONS

**SOT-23
(TO-236)**
CASE 318-08
ISSUE AK



NOTES:

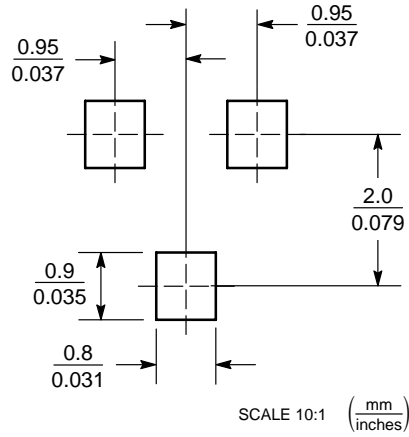
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

STYLE 21:

- PIN 1. GATE
2. SOURCE
3. DRAIN

SOLDERING FOOTPRINT



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